



PRODUCT BULLETIN # 20204Generic Copy

Issue Date: 27-Aug-2013**TITLE:** SLMV358DMR2G part created for Motorola Solutions inventory segregation from LMV358DMR2G**PROPOSED FIRST SHIP DATE:** 29-Aug-2013**AFFECTED CHANGE CATEGORY(S):** Device Ordering Code**FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:**Contact your local ON Semiconductor sales office or <Shannon.riggs@onsemi.com>**NOTIFICATION TYPE:**ON Semiconductor considers this change approved unless specific conditions of acceptance are provided in writing. To do so, contact <quality@onsemi.com>.**DESCRIPTION AND PURPOSE:**

This product bulletin is to announce the creation of inventory segregation special SLMV358DMR2G for Motorola Solutions as required by the corrective action defined in response to EFAR 43924 & 434964.

SLMV358DMR2G is identical in specification to LMV358DMR2G (<http://www.onsemi.com/PowerSolutions/product.do?id=LMV358>) and will only be manufactured with die fabricated in our ON Semiconductor, Gresham, OR, USA facility during the year 2008.

This product bulletin will be fully effective upon the conversion of any existing customer orders/backlog from LMV358DMR2G to SLMV358DMR2G. SLMV358DMR2G can be ordered ONLY until the remaining 2008 die inventory is depleted. Upon depletion of the 2008 die inventory the SLMV358DMR2G device will be discontinued.

List of affected General Parts:

LMV358DMR2G

List of affected Customer Specific Parts:

SLMV358DMR2G